

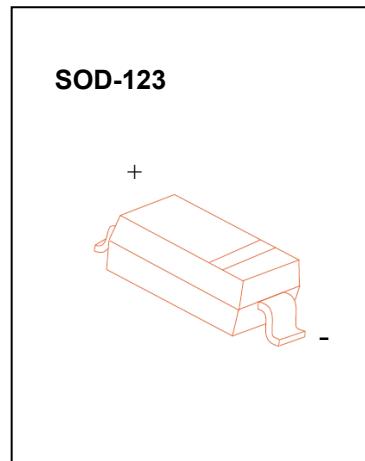


SD101AW /SD101BW /SD101CW

SCHOTTKY DIODES

FEATURES

- Low Forward Voltage Drop
- Guard Ring Construction for Transient Protection
- Negligible Reverse Recovery Time



Maximum Ratings and Electrical Characteristics, Single Diode @T_A=25°C

Parameter Symbol		SD101AW	SD10	1BW	SD101CW	Unit
Peak Repetitive Peak reverse voltage	V _{RRM}					
Working Peak DC Blocking Voltage	V _{RWM}	60		50	40	V
RMS Reverse Voltage	V _{R(RMS)}	42		35	28	V
Forward Continuous Current	I _{FM}			15		mA
Repetitive Peak Forward Current @t<1.0s @t=10μs	I _{FRM}			50		mA
				2.0		A
Power Dissipation	P _d			500		mW
Thermal Resistance Junction to Ambient	R _{θJA}			250		°C/W
Storage temperature	T _{STG}			-65~+150		°C

Electrical Ratings @T_A=25°C

Parameter Symb	ol	Min.	Typ.	Max.	Unit	Condit	ions
Reverse Breakdown Voltage	SD101AW						
	V _{(BR)R}	60			V		IR=10μA
		50					IR=10μA
		40					IR=10μA
Forward voltage	SD101AW			0.41			I _F =1.0mA
	SD101BW			0.40			I _F =1.0mA
	SD101CW			0.39			I _F =1.0mA
	SD101AW			1.00			I _F =15mA
	SD101BW			0.95			I _F =15mA
	SD101CW			0.90			I _F =15mA
Reverse current	SD101AW						V _R =50V
	SD101BW						V _R =40V
	SD101CW						V _R =30V
Capacitance between terminals	SD101AW			2.0			
	SD101BW			2.1			
	SD101CW			2.2	pF		V _R =0V,f=1.0MHz
Reverse Recovery Time	t _{rr}			1. 0	ns		I _F =I _R =5mA
							I _{rr} =0.1XI _R ,R _L =100Ω

LI DE HENG ELECTRONICS
Typical Characteristics SD101A W/SD101BW /SD101CW

1N4148WS/BAV16WS

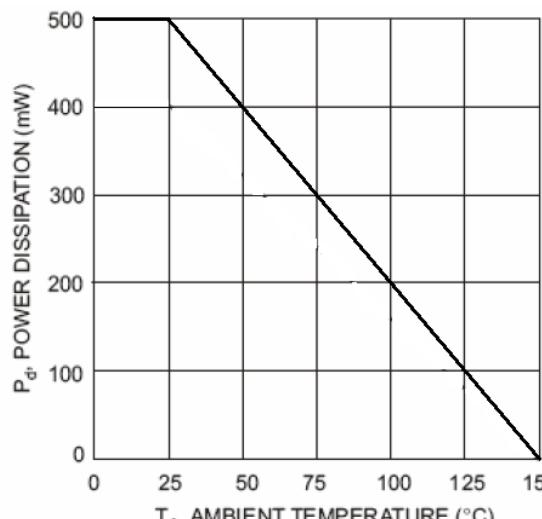


Fig. 1 Power Derating Curve

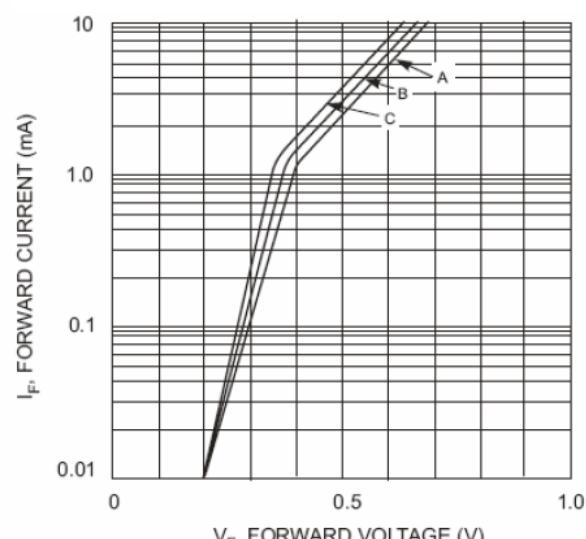


Fig. 2 Typical Forward Characteristic

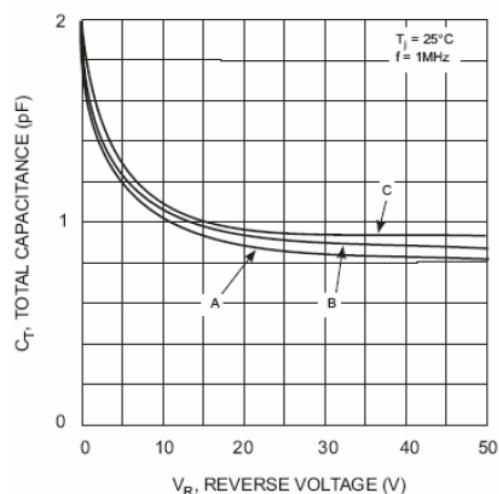


Fig. 3 Typical Total Capacitance vs Reverse Voltage

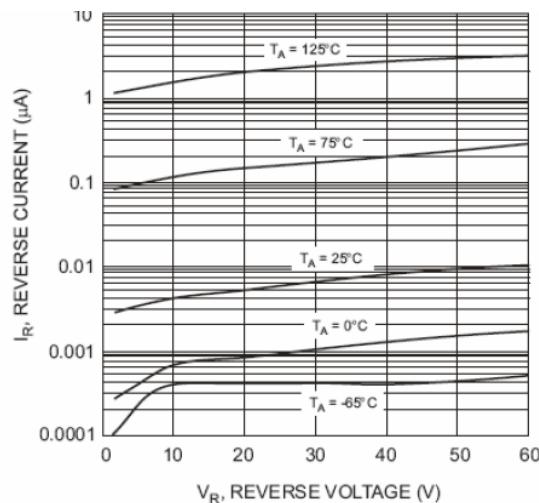


Fig. 4 Typical Reverse Characteristics